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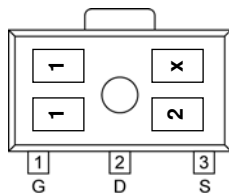
Power MOSFET

■ GENERAL DESCRIPTION

The XP161A1265PR-G is an N-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics. Because high-speed switching is possible, the IC can be efficiently set thereby saving energy. A gate protect diode is built-in to prevent static damage. The small SOT-89 package makes high density mounting possible.

■ APPLICATIONS

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

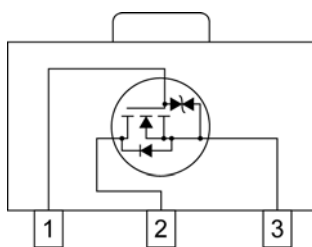
■ PIN CONFIGURATION/
MARKING

G : Gate
S : Source
D : Drain

SOT-89
(TOP VIEW)

* x represents production lot number.

■ EQUIVALENT CIRCUIT



N-channel MOSFET
(1 device built-in)

■ FEATURES

Low On-State Resistance : $R_{ds(on)}=0.055\Omega @ V_{gs}=4.5V$
: $R_{ds(on)}=0.095\Omega @ V_{gs}=2.5V$

Ultra High-Speed Switching

Gate Protect Diode Built-in

Driving Voltage : 2.5V

N-Channel Power MOSFET

DMOS Structure

Small Package : SOT-89

Environmentally Friendly : EU RoHS Compliant, Pb Free

■ PRODUCT NAME

PRODUCTS	PACKAGE	ORDER UNIT
XP161A1265PR	SOT-89	1,000/Reel
XP161A1265PR-G ^(*)	SOT-89	1,000/Reel

^(*) The "-G" suffix denotes Halogen and Antimony free as well as being fully RoHS compliant.

■ ABSOLUTE MAXIMUM RATINGS

$T_a = 25^\circ\text{C}$

PARAMETER	SYMBOL	RATINGS	UNITS
Drain-Source Voltage	V_{dss}	20	V
Gate-Source Voltage	V_{gss}	± 12	V
Drain Current (DC)	I_d	4	A
Drain Current (Pulse)	I_{dp}	16	A
Reverse Drain Current	I_{dr}	4	A
Channel Power Dissipation *	P_d	2	W
Channel Temperature	T_{ch}	150	$^\circ\text{C}$
Storage Temperature	T_{stg}	-55~150	$^\circ\text{C}$

* When implemented on a ceramic PCB

ELECTRICAL CHARACTERISTICS

DC Characteristics

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	Idss	Vds=20V, Vgs= 0V	-	-	10	μ A
Gate-Source Leak Current	Igss	Vgs= ±12V, Vds= 0V	-	-	±10	μ A
Gate-Source Cut-Off Voltage	Vgs(off)	Id= 1mA, Vds= 10V	0.7	-	1.4	V
Drain-Source On-State Resistance*1	Rds(on)	Id= 2A, Vgs= 4.5V	-	0.042	0.055	Ω
		Id= 2A, Vgs= 2.5V	-	0.070	0.095	Ω
Forward Transfer Admittance*1	Yfs	Id= 2A, Vds= 10V	-	8	-	S
Body Drain Diode Forward Voltage	Vf	If= 4A, Vgs= 0V	-	0.85	1.1	V

*1 Effective during pulse test.

Dynamic Characteristics

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss	Vds= 10V, Vgs=0V f= 1MHz	-	320	-	pF
Output Capacitance	Coss		-	190	-	pF
Feedback Capacitance	Crss		-	80	-	pF

Switching Characteristics

Ta = 25°C

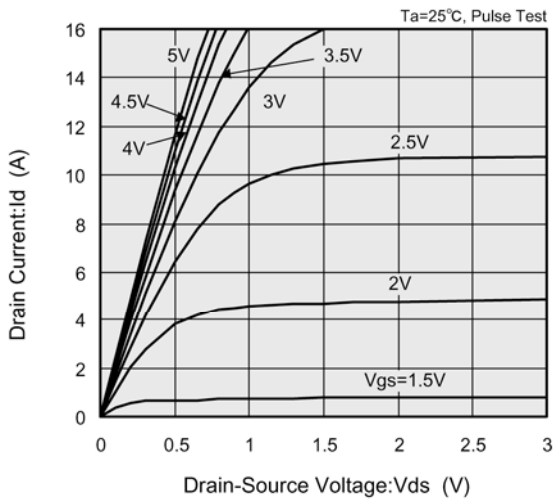
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs= 5V, Id=2A Vdd= 10V	-	10	-	ns
Rise Time	tr		-	15	-	ns
Turn-Off Delay Time	td (off)		-	55	-	ns
Fall Time	tf		-	40	-	ns

Thermal Characteristics

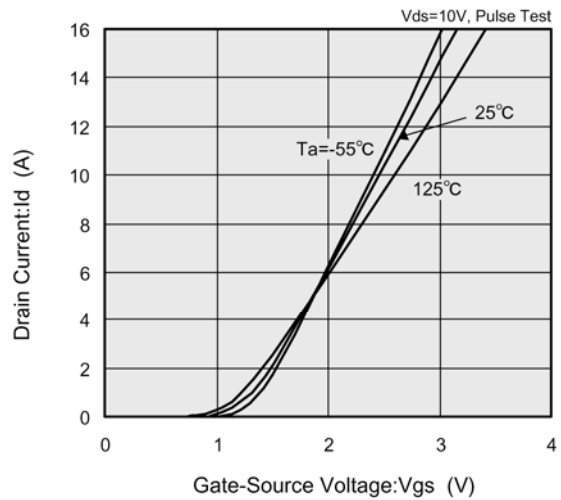
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a ceramic PCB	-	62.5	-	°C/W

TYPICAL PERFORMANCE CHARACTERISTICS

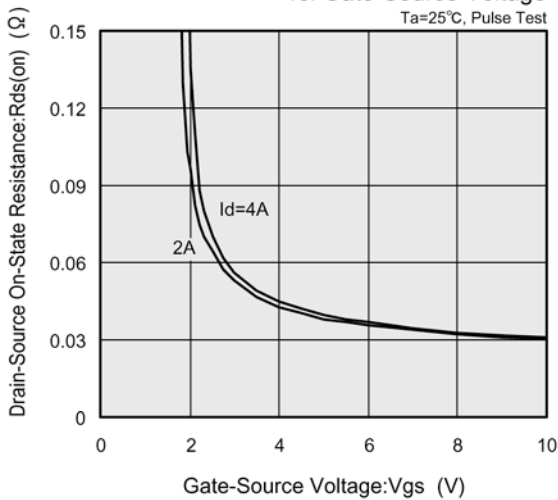
(1) Drain Current vs. Drain-Source Voltage



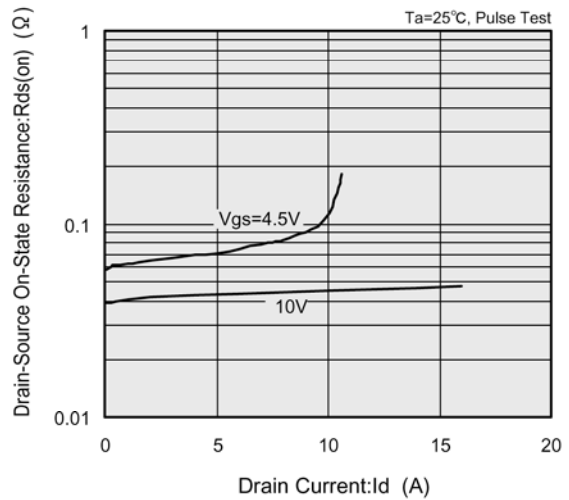
(2) Drain Current vs. Gate-Source Voltage



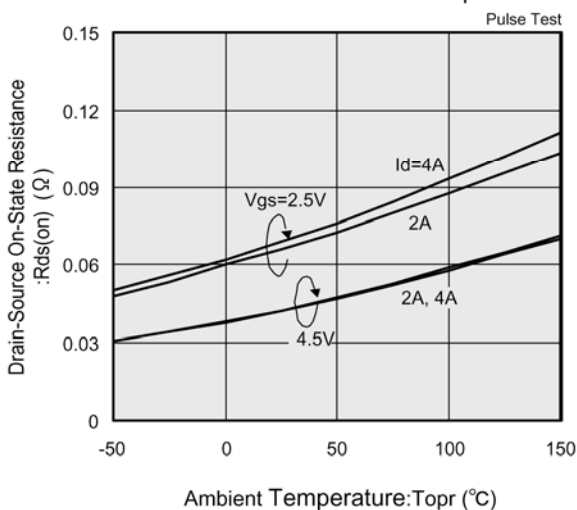
(3) Drain-Source On-State Resistance vs. Gate-Source Voltage



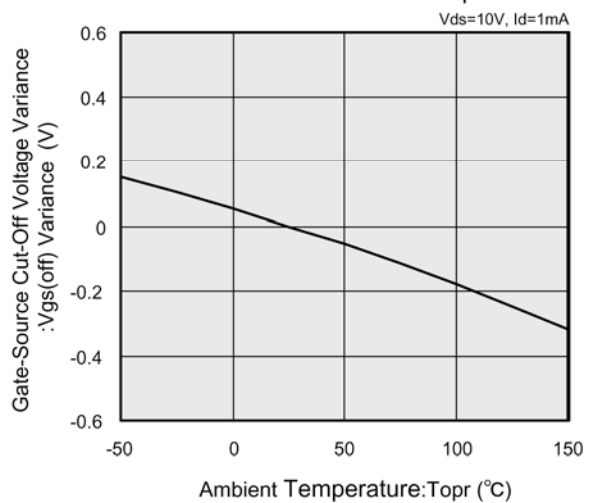
(4) Drain-Source On-State Resistance vs. Drain Current



(5) Drain-Source On-State Resistance vs. Ambient Temperature

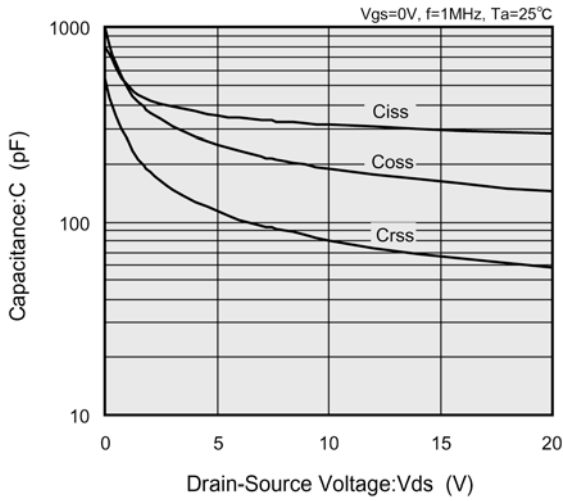


(6) Gate-Source Cut-Off Voltage Variance vs. Ambient Temperature

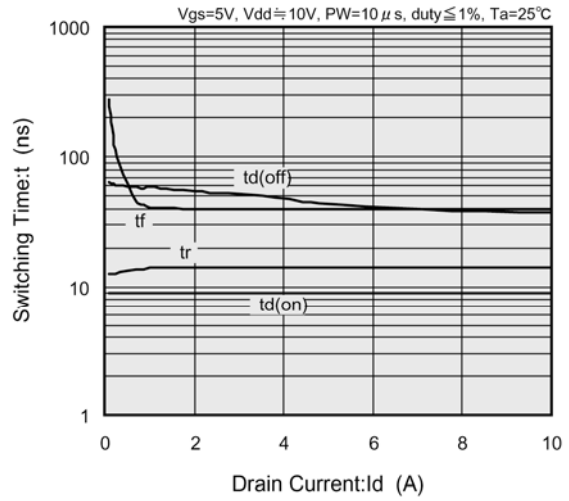


TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

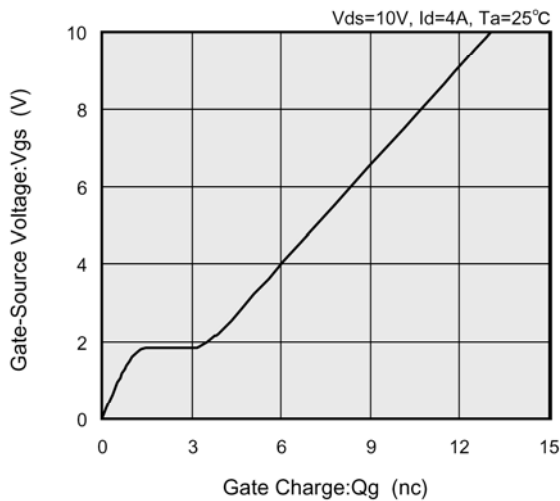
(7) Capacitance vs. Drain-Source Voltage



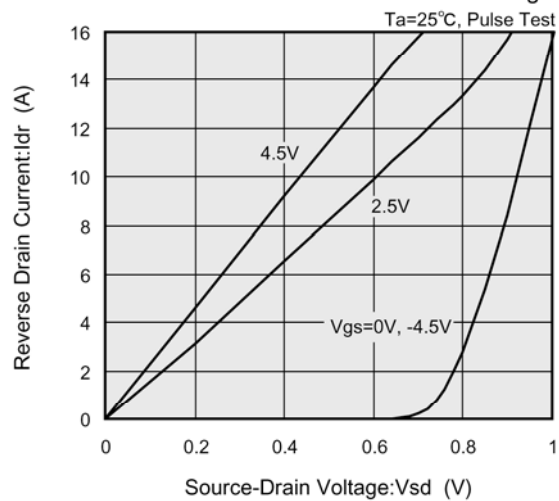
(8) Switching Time vs. Drain Current



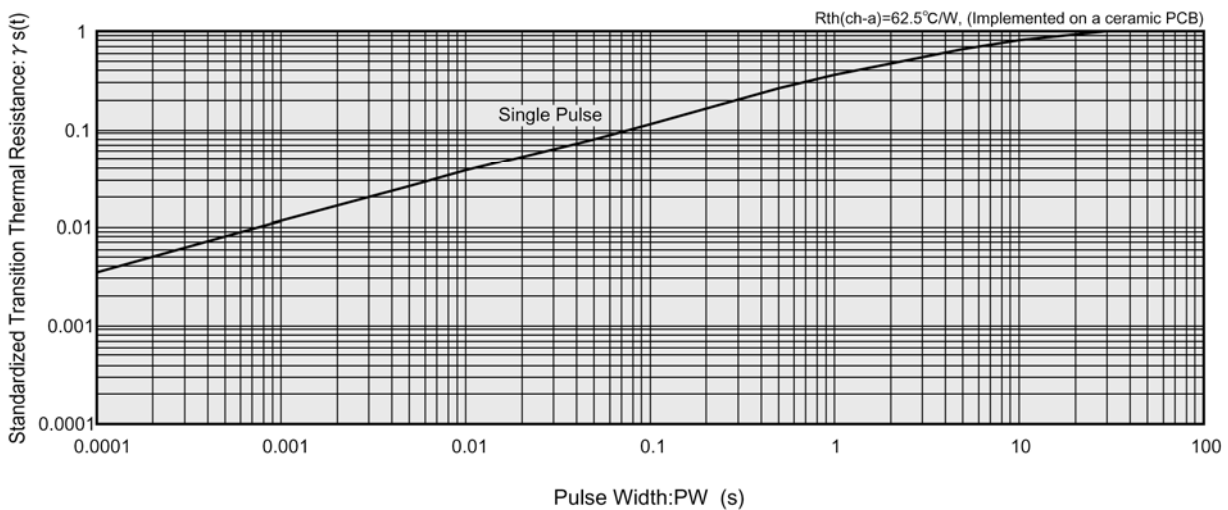
(9) Gate-Source Voltage vs. Gate Charge



(10) Reverse Drain Current vs. Source-Drain Voltage



(11) Standardized transition Thermal Resistance vs. Pulse Width



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